COEN-4730/EECE-5730 Computer Architecture

# Lecture 11 Servers, Reliability, and Power (Ch.6)

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**D**ept. of Electrical and Computer Engineering



BE THE DIFFERENCE.

Credits: Slides adapted from presentations of Sudeep Pasricha and others: Kubiatowicz, Patterson, Mutlu, Elsevier

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### **Outline**

- Servers
- Availability, Reliability
- Power

### What is a Server?

### A computer specialized for business users

- ° File server, data server, application server
- ° Database, file and printer sharing, email server
- ° Web server, DNS server, firewall server, ftp server
- ° Business applications: payroll, enterprise resource planning, customer relationship management
- ° Small business
- ° Big enterprise

Servers

CPUs

DRAM

Disks

Clusters

Packs

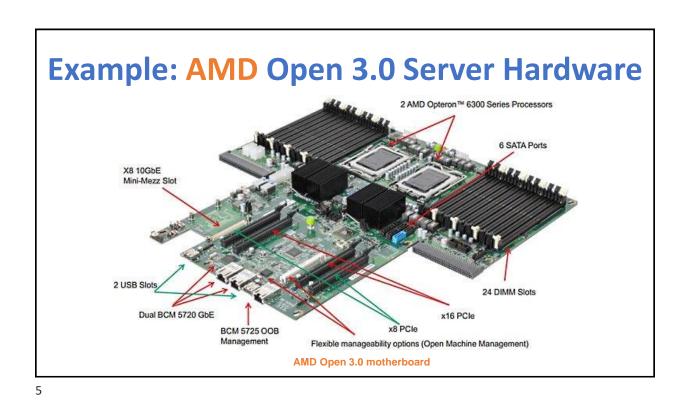
+ 40-80 servers

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# **Example: FB Datacenter Racks**







# Example: ASRock 1U12LW-C2750 Server



### **Desktop vs. Server**

Desktop	Server
1-2 Desktop CPUs	Up to 64 server CPUs
192GB memory max	2 TB memory max
7 PCI/PCIe slots	Up to 192 PCIe slots
Fast high-res video	Basic video
Typically SATA disks	SAS, SATA, SSD, SCSI disks
Single user applications	Multi-user applications
Sound and multi-media	No sound systems
Monitor, keyboard, mouse	Shared/remote KVM
Designed for 9x5 operations	Designed for 24x7 operations
Little to no high-availability features	High availability and redundancy
Little to no manageability features	Support for manageability

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# **Key Server Requirements**

- Metrics tied to business value
  - ° Reliability error-free operation as per-specifications
  - Availability uptime of system including fault-tolerant operation

**IRAS** 

- ° Serviceability maintain server (install, upgrade, debug)
- ° Scalability handle increasing amounts of workload
  - ° Security avoid vulnerabilities; protect data
  - ° Performance
  - ° Costs

### **Server Components**

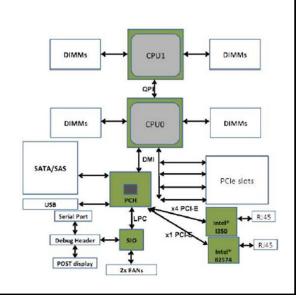
- CPU for processing
  - ° Intel Xeon, Itanium, AMD Opteron, IBM POwer7
  - ° 1-64 CPUs in multiple sockets
- Memory and storage of data/OS, etc.
  - ° DDR, DDR2, DDR3, ...
  - ° Serial ATA (SATA), SCSI, Serial Attached SCSI (SAS), Fibre Channel
  - ° Direct Attached Storage (DAS), Network Attached Storage (NAS), Storage Area Network (SAN)
- •I/O Bus and network interface for communication
  - ° Ethernet, PCIExpress, ...
- Operating Systems
  - ° Windows server, Unix, Linux, Solaris, ...

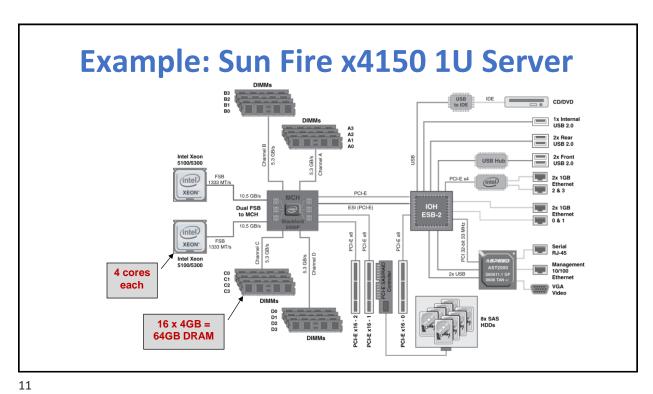
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### 2-socket Server Basic Architecture

- •1-2 multicore chips
- •8-16 DIMMS
- •1-2 Ethernet ports
- •2-6 internal SATA/SAS disks
- External storage expansion
- Configuration/size vary
  - $^{\circ}$  Depends on tier role
  - ° 1U-2U (1U = 1.75 inches)





# **Example Configurations**

• Facebook server configurations for different services

Standard	l	III	IV	V	VI
Systems	Web	Database	Hadoop	Haystack	Feed
CPU	High	Med	Med	Low	High
	2 x E5-2670	2 x E5-2660	2 x X5650	1 x L5630	2 x E5-2660
Memory	Low	High	Medium	Low	High
	16GB	144GB	48GB	18GB	144GB
Disk	Low	High IOPS	High	High	Medium
	250GB	3.2 TB Flash	12 x 3TB SATA	12 x 3TB SATA	2TB SATA
Services	Web, Chat	Database	Hadoop	Photos, Video	Multifeed, Search, Ads

### **Server Form Factors**

### Tower chassis servers

- ° Upright free-standing units + full systems
- ° Affordable, entry-level server for small/remote offices

### Rackmount servers

- Complete server optimized for ultra-compact vertical arrangement within a standard 19inch mounting rack/cabinet
- ° Flexible, located in computer rooms or datacenters

### Blade servers

- Small form-factor servers housed in blade enclosures designed for modularity and highdensity footprints
- Very efficient use of space, amortized sharing of power supplies, fans, networking. Used in datacenters. Growing segment.

### Micro-slice servers

- ° Multiple small server boards share an enclosure
- ° Amortize cost of enclosure, disks, switch, power supply....



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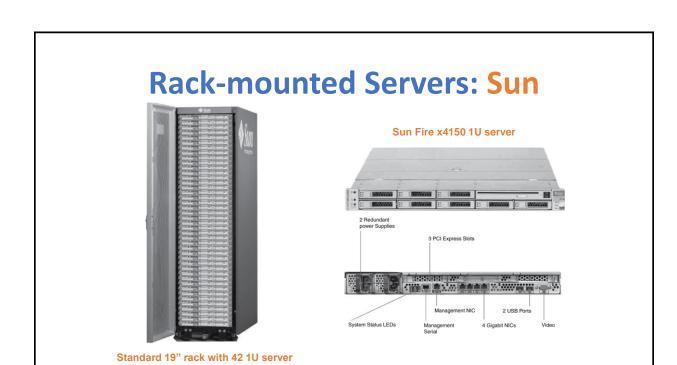
# **Rack-mounted Servers**

- •Typically, 19 or 23 inches wide
- •Typically, 42 U
  - ° U is a rack unit, 1.75 inches

•Slots:







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# **Blade Servers: HP C7000**

- 10U enclosure for standard racks
- 16 half-height blades or 8 full-height blades
- Hot-pluggable; small form-factor SAS/SATA drives
- Power supplies
  - ° 6x 2250 power supplies, or 2400 W power supplies
  - ° 12V DC supply, no-redundancy, N+N redundancy, N+1 redundancy
  - ° AC power = 3-phase or single phase 48V DC
- 10 ActiveCool fans
  - ° Side ducts for interconnect modules
  - ° Separate fans for power supplies
- 8 Interconnect bays single-wide or double-wide
  - ° VC Eth, VC FC, Eth, IB, storage switches
  - ° Gig Eth, 10Gig Eth, 4GB/8Gb FC, SAS, 4x DDR (20GB)
- Passive shared power backplane and active signal midplane
  - ° 5Tb/s aggregate BW
- Two bays for on-board administrator module
  - "Dynamic power saver", for subset of power supplies, dynamic power capping, fan management, enclosur troubleshooting, iLO access, DVD media sharing, ...
  - $^{\circ}$  Sensors, thermal conditions, power conditions, system configuration, management network
  - ° Systeme status display, HP insight manage



### **Enclosure-level Density Optimization**

### Objective functions

- Minimum costs min blade costs (max blades per enclosure to amortize costs) and min switch costs (number of internal and external ports in switches)
- Constrained by volume space within enclosure, minimum space required for server-class components, max power budget for server blade
- Maximum flexibility maximize switches for various network protocols, maximize performance of blades (highest power budget and volume) and switches (highest network speed protocols and highest external network connectors)
- Multi-objective optimization across power envelope, per server volume space, switch bandwidth oversubscription ratio, network protocols, ...

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# Platform (HW) Management

### Management tasks

° Turn on/off, recovery from failure (reboot after system crash), system events and alerts log, console (keyboard, video, and mouse (KVM)), monitoring (health), power management, installation (boot OS image)

### Platform management system

- ° Automates all these operations
- ° Out-of-Band (OOB), secure (privileged access point to the system), low-power (always on), flexible and low-cost

# **Management Processors**

- An embedded computer on each server
  - ° Custom processors: e.g., HP iLO (Integrated Lights-Out)
  - Small processor core, memory controller, dedicated NIC, specialized devices (Digital Video Redirection, USB emulation)
  - ° E.g., IBM remote supervisor adapter (RSA), Dell remote assistant card (DRAC)
- Some iLO functions
  - ° Video redirection (textual console, graphic console)
  - ° Power management (monitoring, regulator, capping)
  - ° Security (authentication, authorization, directory services, data encryption, ...)
- Standards: Intelligent Platform Management Interface (IPMI)
  - ° Baseboard management controller (simpler interfaces/functionality)





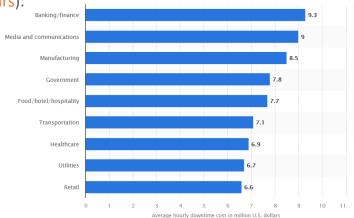
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### **Outline**

- Servers
- Availability, Reliability
- Power

# Why is Availability Important?

- Mission-critical (100% uptime), business-critical (minimal interruptions)
- Average cost per hour of server downtime worldwide, by vertical industry (in million U.S. dollars):



Source: https://www.statista.com/statistics/780699/worldwide-server-hourly-downtime-cost-vertical-industry/

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# **Availability Classifications**

- Availability quoted in "9s"
  - ° E.g., Telephone system has five 9s availability
  - ° 99.999% availability of 5 minutes downtime per year

Uptime	Downtime in one year
99% (two 9's)	87.6 hours
99.9% (three 9's)	8.76 hours
99.99% (four 9's)	53 min
99.999% (five 9's)	5 min
99.9999% (six9's)	32 sec
99.99999% (seven 9's)	3 sec

# **Datacenter Availability**

- Mostly system-level, SW-based techniques
  - ° Using clusters for high availability
    - Active/standby; active/active
    - Shared-nothing/shared-disk/shared-everything
- Reasons
  - ° High cost of server-level techniques
    - · Cost of failures vs. cost of more reliable servers
  - ° Cannot rely on all servers working reliably anyway
    - Example: with 10K servers rated at 30 years of MTBF, you should expect to have 1 failure/day
- But, components must be reliable enough...
  - ° ECC based memory used detection is important!

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# **Types of Faults**

- Permanent
  - ° Defects, bugs, out-of-range parameters, wear out, ...
- Transient (temporary)
  - ° Radiation issues, power supply noise, EMI, ...
- Intermittent (temporary)
  - ° Oscillate between faulty and non-faulty operations
  - ° Operation margin, weak ports, ...

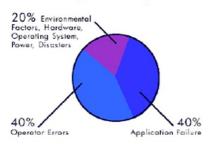
# **Real-world Service Disruptions**

- Large number of techniques on hardware fault-tolerance
- Software, operator, maintenance-induced faults
  - ° Affect multiple systems at once

### Source of "disruptions events" at Google

# 35 30 25 30 25 315 30 Config Software Human Network Hardware Other

### Source of enterprise "disruption events"



Disruption event = service degradation that triggered operations team scrutiny

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# **Improving MTTF & MTTR**

### Two issues

- ° Error detection
- ° Error correction

### Observations

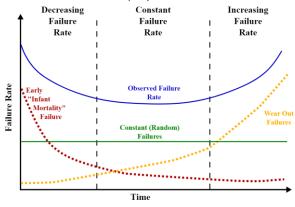
- ° Both are useful (e.g., fail-stop operation after detection)
- ° Both add to cost; so, use carefully
- ° Can be done at multiple levels (HW/SW)
  - General, chip, disks, memories, networks, system, DC

### Some terminology

- ° Fail-fast either function correctly or stop when error detected
- ° Fail-silent system crashes on failure
- ° Fail-stop system stops on failure
- ° Fail-safe automatically counteracting a failure

## **General: "Infant Mortality"**

- Many failures happen in early stages of use
  - ° Marginal components, design/SW bugs, etc.
- Use "burn-in" testing to screen such issues
  - ° E.g., Stress test HW and SW before deployment



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### **Extensive Validation**

### High-level steps

- ° Units built in a way that simulates factory methods
- All components evaluated: electrical, mechanical, software bundles, firmware, system interoperability
- ° Failure diagnostics and interaction with design team
- ° Potential beta customer testing

### Extensive testing

- ° Accelerated thermal lifetime testing (-60C to 90C)
- ° Accelerated vibration testing
- ° Manufacturing verification
- ° Reliability of user interface and full rack configuration
- ° Static discharge, repetitive mechanical joints, etc.
- ° Dust chamber: simulate dust buildup
- ° Environmental testing: model shipping stresses
- $^{\circ}\,$  Acoustic emissions and EMI standards
- ° FCC approval (US), CE approval (EU)
- $^{\circ}\,$  Power fluctuations and noise: semi-anechoic chamber
- ° On-site datacenter testing: TPC benchmarking



### **RAID: Dealing with Faults in Storage Systems**

- Redundant Arrays of Inexpensive Disks (RAID)
  - ° A collection of disks that behaves like a single disk with: High capacity, high bandwidth, high reliability
  - ° Key idea in RAID: error correcting information across disks
  - o Many organizations; two distinguishing features:
    - Granularity of the interleaving (bit, byte, block)
    - Amount and distribution of redundant information
  - Patterson's classification RAID levels 0 to 6:

Level	Description
RAID0	Block-level striping without parity mirroring
RAID 1	Mirroring without parity striping
RAID 2	Bit-level striping with dedicated parity
RAID 3	Byte-level striping with dedicated parity
RAID 4	Block-level striping with dedicated parity
RAID 5	Block-level striping with distributed parity
RAID 6	Block-level striping with double-distributed parity
RAID 1+0	Disk mirroring and data striping without parity

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### **Dealing with Faults in Memories**

- Permanent faults (Stuck at 0/1 bits)
  - °Address with redundant rows/columns; i.e., spares
  - \*Built-in-Self-Testing (BIST) and fuses to program decoders
- Transient faults
  - ° Bits flip 0->1 or 1->0
  - ° Parity
    - Add a 9<sup>th</sup> bit
    - E.g., Even parity: make 9th bit 1 if number of ones in byte is odd

# **Dealing with Network Faults**

### Use error detecting codes and retransmissions

- ° CRC: cyclic redundancy code
- ° Receiver detects error and requests retransmission
  - Requires buffering at the sender side
- ° An Ack/Nack protocol is typically used
  - To indicate when receiver received correct data or not
- ° Timeouts to deal with situations of lost messages
  - Error in control signals or with acknowledgements

### Permanent faults

° Use network with path diversity

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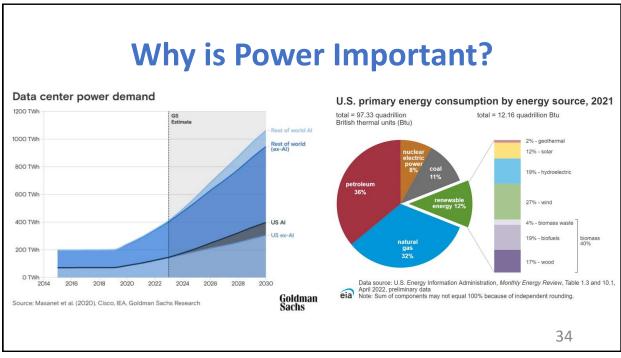
# **Dealing with Faults in Logic**

- Triple modular redundancy (TMR)
  - ° Three copies of compute unit + majority voter
  - ° Issues: synchronization & common mode errors
- Dual modular redundancy (DMR)
  - $^{\circ}$  Two copies of compute unit + comparator
  - $^{\circ}$  Can use simpler  $2^{nd}$  copy (e.g., parity detector)
- Checkpoint & restore
  - $^{\circ}$  Periodic checkpoints of state
  - ° On error detection, rollback & re-execute from checkpoint
  - $^{\circ}$  Issues: checkpoint interval, detection speed, number of checkpoints, recovery time,  $\ldots$

### **Outline**

- Servers
- Availability, Reliability
- Power

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### Why is Power Important?

### Desire to reduce electricity use

- ° For mobile devices, impacts battery life
- ° For tethered devices, impacts electricity costs
  - · Delivery of power to buildings
  - Gets worse with large datacenters (\$7M for 100 racks)

### Environmental friendliness

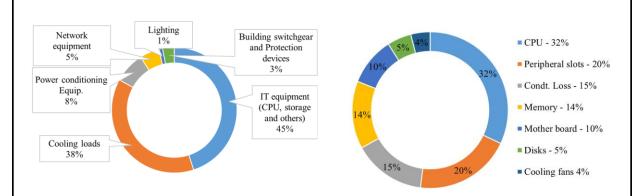
- ° Compute equipment energy use has been increasing (e.g., training LLM such as ChatGPT and others)
- ° Need to reduce amount of CO2 emissions

### Power delivery, packaging, cooling costs

- ° At high-end 1W cooling for 1W of power!
- Compaction, density, reliability
  - ° Thermal failures
    - 50% server reliability degradation for +10C
    - 50% decrease in hard disk lifetime for +15C

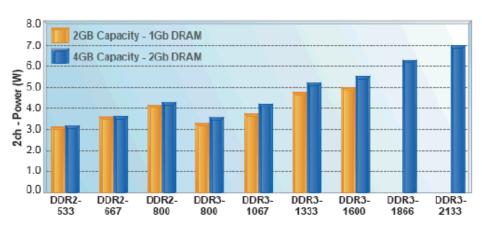
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# Power Consumption - Datacenter and Server Levels



Source: K. M. U. Ahmed, M. H. J. Bollen and M. Alvarez, "A Review of Data Centers Energy Consumption and Reliability Modeling," in IEEE Access, vol. 9, pp. 152536-152563, 2021, doi: 10.1109/ACCESS.2021.3125092. 36





RDIMM Memory Power Comparison (Source: Intel Platform Memory Operation)

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# **Power Consumption in ICs**

 $P = C*Vdd^2*F_{0\rightarrow 1} + Tsc*Vdd*Ipeak*F_{0\rightarrow 1} + Vdd*I_{leakage}$ 

- Dynamic (active) power consumption
  - Charging/discharging capacitors
  - ° Depends on switching activity
- Short circuit currents
  - ° Short circuit path between power rails during switching
  - ° Depends on size of transistors
- Leakage current or static power consumption
  - ° Leaking transistors, diodes
  - ° Gets worse with technology downscaling and lower Vdd
  - ° Gets worse with higher temperatures

### **Metrics**

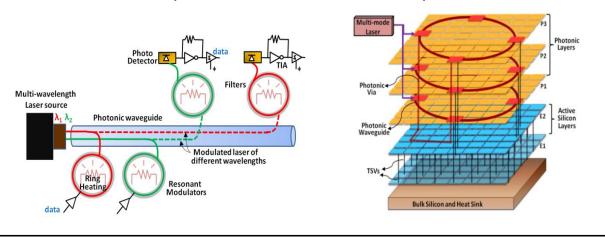
- •Energy (Joules) = Power (Watts) \* Time (sec)
  - ° Power limited by infrastructure (power supply)
- •Power density = power/area
  - ° The major metric for system cooling
- Combined metrics
  - ° How to trade off performance for power savings
  - ° Energy-Delay-Product (EDP), ...

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### **Landscape of Optimizations – Across Layers** $P = C*Vdd^{2*}F_{0\rightarrow 1} + Tsc*Vdd*Ipeak*F_{0\rightarrow 1} + Vdd*I_{leakage}$ Average power, peak power, power density, energy-delay, ... ARCHITECTURE CIRCUITS \* COMPILER, OS, APP Switching control Voltage/freq scaling Voltage scaling/islands Gating Clock gating/routing nuction scheduling Pipeline, clock, functional units, Clock-tree distribution, half-swing clocks branch prediction, data path Memory access reduce Redesigned latches/flip-flops Split instruct windows pin-ordering, gate restructuring, topology restructuring, balanced delay paths, optimized bit SMT thread throttling Power-mode-control transactions CPU/resource schedule Redesigned memory cells Bank partitioning · Memory/disk control Low-power SRAM cells, reduced bit-line swing Cache redesign Disk spinning, page allocation, mer mapping, memory bank control multi-Vt, bit line/word line isolation/segmentation Sequential, MRU, hash-rehash, Other optimizations column-associative, filter cache, sub- Networking Transistor resizing, GALS, low-power logic banking, divided word line, block Power-aware routing, proximity-based buffers, multi-divided module, scratch routing, balancing hop count, Low-power states Distributed computing DRAM refresh-control Switching control Gray, bus-invert, address-incre Fidelity control · Code compression · Dynamic data types Data packing/buffering Power API

### **Replace Copper Wires with Optics**

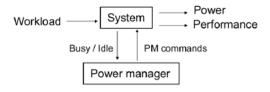
- Networks-on-chip (NoCs) have high latency and power dissipation
- What if we used photonic interconnects on chip?



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# **Power Management**

- Components with multiple power modes/states
  - ° Active: different levels of performance/power consumption
  - ° Idle: different power consumption/wake-up time
- Select power states to match constraints
  - ° Exploit fluctuations in use
  - ° Done in HW/SW and/or by user
  - ° Tradeoffs: power saving Vs. QoS Vs. speed of resuming



### **Advanced Configuration and Power Interface (ACPI)**

### Standard for power management of systems

- ° Describes power stages for system, cores, devices,...
- ° Interface for SW to query and manage power states

### Global system states

- °G0: working system in responsive, user application run
- °G1: sleeping appears to be off. Within G1:
  - S1 (caches flushed, CPU halted)
  - S2 (CPU power off)
  - S3 (suspend to RAM)
  - S4 (hibernate to storage)
- °G2: soft off (wakeup on LAN)
- °G3: hard off (mechanical)

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### **Advanced Configuration and Power Interface (ACPI)**

### Device states

- ° D0 fully on operating state
- ° D1 and D2 are intermediate states (vary by design)
- ° D3 is powered off state (device unresponsive)

### Processor states

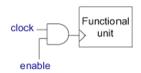
- ° CO is fully on
- ° With P states related to DVFS stages
- ° C1 to C3 are idle modes
- ° Clock may be stopped, but, state is maintained
- ° C4 and beyond are various power off state
- ° First the cache, then cores, and finally the whole chip

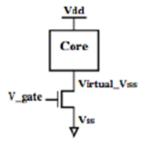
### **Power Management in Processors**

- Clock gating of idle units
  - ° Clock is major power contributor
  - ° Done automatically in most designs
  - ° Near instantaneous on/off behavior

### Power gating (C4 and beyond)

- ° Turn off power to unused cores/caches
- ° Large delay for on/off
  - Saving SW state, flushing dirty cache lines, turn off clock tree
  - Carefully done to avoid voltage spikes or memory bottlenecks
- ° Area & power consumption of gate
- ° Opportunity: use thermal headroom for other cores





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# **Dynamic Voltage and Frequency Scaling (DVFS)**

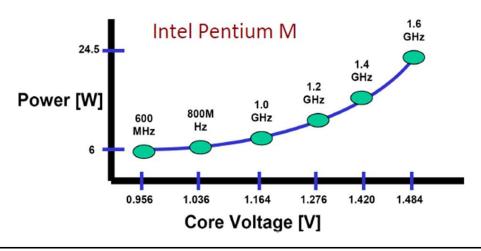
- Set frequency to lowest needed
- Scale back Vdd to lowest required by that frequency
  - ° Lower voltage => slower transistors
  - ° Power = CL \* Vdd<sup>2</sup> \* f

### Provides P states for power management

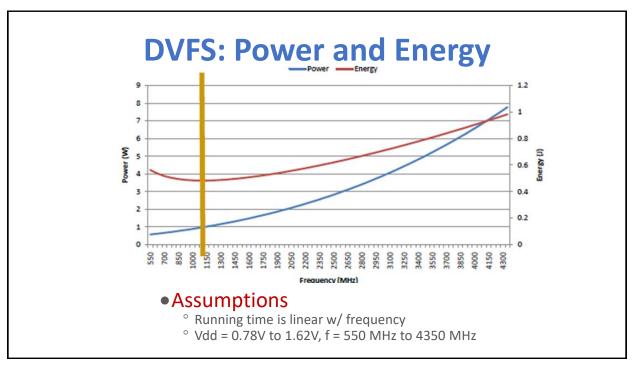
- ° Heavy load: frequency, voltage, power high
- ° Light load: frequency, voltage, power low
- ° Tradeoff: power savings Vs. overhead of scaling
- ° Effectiveness limited by voltage range

# **Example DVFS Implementation**

• Transitions between VF pair typically take a few microseconds



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### **DRAM Power States**

Power State	Operating Mode	Resync -time	% Active power
Active	All modules ready	0 cycles	100%
Standby	Column multiplexers disabled	2 cycles	60%
Napping	Row decoders turned off	30 cycles	10%
Power Down	Clock sync to Controller interface turned off	9000 cycles	1%
Disabled	No refresh; data lost	Reboot	0%

•Example: 5 states in DR-DRAM

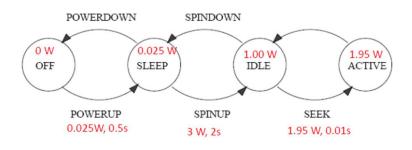
Tradeoff: power savings Vs. resync penalty

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### **Disk Drive Power Modes**

### Common optimization

- ° Stop spinning disk when it is unused for a certain period of time
- ° Example: Toshiba notebook drive



# **Display Power Management**

- Turn-off displays, use smaller displays
- Energy-aware user-interface
  - Spatial focus on informational content
  - ° Temporal focus on content of interest at given time
  - ° Reduced energy (2-10X) and better ease-of-use
- Leverage usability-friendly energy-reducers
  - ° E.g., Contrast, personalization, visibility of surrounding text



Global savings of 8.3 Megawatt-hours per day if Google switched to black background!

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### Per-server Power Management: e.g., HP Power Regulator

- Monitor & manage individual and groups of servers by physical or logical location (power domain)
- Monitor vital power information
  - Power consumption in Watts
  - ° BTU/hr output
    - British Thermal Unit (BTU) per Hour: is a measurement of heat energy.
    - One BTU is amount of heat required to raise one pound of water by one degree Fahrenheit.
  - ° Ambient air temperature

### Policy based power management

- Power cap policy: Set maximum BTUs/hr or Wattage threshold (capped on a server by server basis)
- ° Temporary conservation policy: Set time of day to drop to lower selected priority servers into lower power state
- Severe facility issue: Drop lower priority servers into lower power state when sever facility issues occur
- ° Energy efficiency policy: Set all servers in power domain to dynamic power regulating

### **Cluster-level Power Management**

- Power-aware load distribution to a server cluster
  - ° Try to create idle resources to send to low-power/off states
  - ° Sophisticated policies (predictions, economy-based, batching)
  - ° Interactions between intra-server DVS and inter-server load balancing
  - ° Impact of heterogeneity
  - Interactions with performance and more broadly service-level agreements (SLAs)

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# Readings

- Luiz André Barroso, Jimmy Clidaras, and Urs Hölzle, The Datacenter as a Computer, An Introduction to the Design of Warehouse-Scale Machines, Second Edition, 2013 (Ch.3-6):
  - https://link.springer.com/book/10.1007/978-3-031-01761-2
- Hot Chips: A Symposium on High Performance Chips
  - <a href="https://www.hotchips.org/archives/">https://www.hotchips.org/archives/</a>
- Open Compute: <u>www.opencompute.org</u>
- Google: https://www.google.com/about/datacenters/
- Top 500: https://www.top500.org/lists/top500/

## **Assignment**

- Search online about how AI is used & impacting design and management of servers and datacenters/WSCs
- Write report to summarize your findings
- Upload report to D2L

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